

Features

- Low C_{RES} / C_{IES} ratio (no cross-conduction susceptibility)
- Very soft ultra fast recovery antiparallel diode

Applications

- Very high frequency operation
- High frequency lamp ballast
- SMPS and PFC (including hard switching)

Description

This series of hyper fast IGBT is based on PowerMESH technology and exhibits very low turn-off energy, thanks to a new lifetime control system. This results in an optimized trade-off between on-state voltage and switching losses, allowing very high operating frequencies.

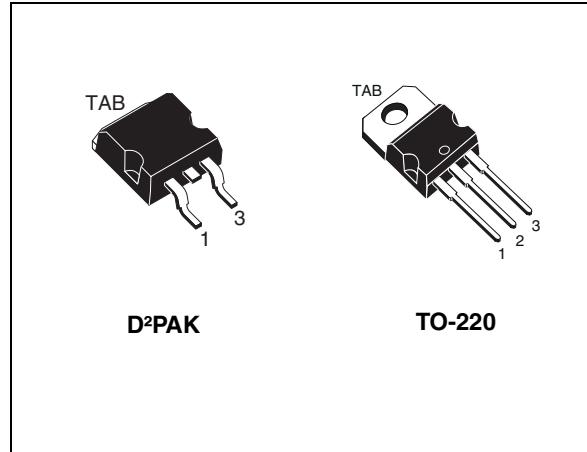


Figure 1. Internal schematic diagram

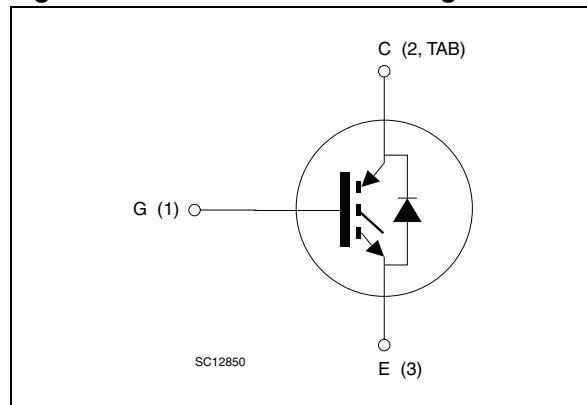


Table 1. Device summary

Order codes	Marking	Package	Packaging
STGBL6NC60DT4	GBL6NC60D	D²PAK	Tape and reel
STGPL6NC60D	GPL6NC60D	TO-220	Tube

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1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-emitter voltage ($V_{GE} = 0$)	600	V
$I_C^{(1)}$	Collector current (continuous) at $T_C = 25^\circ C$	14	A
$I_C^{(1)}$	Collector current (continuous) at $T_C = 100^\circ C$	6	A
$I_{CL}^{(2)}$	Turn-off latching current	18	A
$I_{CP}^{(3)}$	Pulsed collector current	18	A
V_{GE}	Gate-emitter voltage	± 20	V
I_F	Diode RMS forward current at $T_C = 25^\circ C$	7	A
I_{FSM}	Surge non repetitive forward current $t_p = 10$ ms sinusoidal	20	A
P_{TOT}	Total dissipation at $T_C = 25^\circ C$	56	W
V_{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink ($t = 1$ s; $T_C = 25^\circ C$)	--	V
T_j	Operating junction temperature	-55 to 150	$^\circ C$

1. Calculated according to the iterative formula:

$$I_C(T_C) = \frac{T_{j(max)} - T_C}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_C(T_C))}$$

2. $V_{clamp} = 80\%, (V_{CES})$, $T_j = 150^\circ C$, $R_G = 10 \Omega$, $V_{GE} = 15$ V

3. Pulse width limited by max junction temperature allowed

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case IGBT max.	2.2	$^\circ C/W$
	Thermal resistance junction-case diode max.	4	$^\circ C/W$
$R_{thj-amb}$	Thermal resistance junction-ambient max.	62.5	$^\circ C/W$

2 Electrical characteristics

$T_{CASE} = 25^\circ\text{C}$ unless otherwise specified.

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)CES}$	Collector-emitter breakdown voltage ($V_{GE} = 0$)	$I_C = 1 \text{ mA}$	600			V
$V_{CE(\text{sat})}$	Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, I_C = 1.5 \text{ A}$ $V_{GE} = 15 \text{ V}, I_C = 3 \text{ A}$ $V_{GE} = 15 \text{ V}, I_C = 3 \text{ A}, T_C = 125^\circ\text{C}$		1.9 2.2 2	2.9	V V V
$V_{GE(\text{th})}$	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 250 \mu\text{A}$	3.75		5.75	V
I_{CES}	Collector cut-off current ($V_{GE} = 0$)	$V_{CE} = 600 \text{ V}$ $V_{CE} = 600 \text{ V}, T_C = 125^\circ\text{C}$			50 5	μA mA
I_{GES}	Gate-emitter leakage current ($V_{CE} = 0$)	$V_{GE} = \pm 20 \text{ V}$			± 100	nA
g_{fs}	Forward transconductance	$V_{CE} = 15 \text{ V}, I_C = 3 \text{ A}$		3		S

Table 5. Dynamic electrical characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
C_{ies} C_{oes} C_{res}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{CE} = 25 \text{ V}, f = 1 \text{ MHz}$, $V_{GE} = 0$		208 32.5 5.4		pF pF pF
Q_g Q_{ge} Q_{gc}	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 390 \text{ V}, I_C = 3 \text{ A}$, $V_{GE} = 15 \text{ V}$ (see Figure 17)		12 2.6 4.9		nC nC nC

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$ t_r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}$, $I_C = 3 \text{ A}$ $R_G = 10 \Omega$, $V_{GE} = 15 \text{ V}$ (see Figure 18)		6.7 3.7 930		ns ns A/ μs
$t_{d(on)}$ t_r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}$, $I_C = 3 \text{ A}$ $R_G = 10 \Omega$, $V_{GE} = 15 \text{ V}$, $T_C = 125^\circ\text{C}$ (see Figure 18)		6.5 4 820		ns ns A/ μs
$t_r(V_{off})$ $t_d(off)$ t_f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}$, $I_C = 3 \text{ A}$, $R_{GE} = 10 \Omega$, $V_{GE} = 15 \text{ V}$ (see Figure 18)		17 46 47		ns ns ns
$t_r(V_{off})$ $t_d(off)$ t_f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V}$, $I_C = 3 \text{ A}$, $R_{GE} = 10 \Omega$, $V_{GE} = 15 \text{ V}$, $T_C = 125^\circ\text{C}$ (see Figure 18)		35 67 55		ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$E_{on}^{(1)}$ $E_{off}^{(2)}$ E_{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390 \text{ V}$, $I_C = 3 \text{ A}$ $R_G = 10 \Omega$, $V_{GE} = 15 \text{ V}$ (see Figure 18)		46.5 23.5 70		μJ μJ μJ
$E_{on}^{(1)}$ $E_{off}^{(2)}$ E_{ts}	Turn-on switching losses Turn-off switching losses Total switching losses	$V_{CC} = 390 \text{ V}$, $I_C = 3 \text{ A}$ $R_G = 10 \Omega$, $V_{GE} = 15 \text{ V}$, $T_C = 125^\circ\text{C}$ (see Figure 18)		67.5 46 113.5		μJ μJ μJ

1. Eon is the turn-on losses when a typical diode is used in the test circuit in (see Figure 19). If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25°C and 125°C)
2. Turn-off losses include also the tail of the collector current

Table 8. Turn-off with snubber

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
t_f $E_{off}^{(1)}$	Current fall time Turn-off switching losses	$V_{CC} = 200 \text{ V}$, $I_C = 1.5 \text{ A}$ $R_G = 22 \Omega$, $V_{clamp} = 400 \text{ V}$, $L = 1 \text{ mH}$, C-snubber = 2.7 nF (see Figure 18)		16 1.6		ns μJ
t_f $E_{off}^{(1)}$	Current fall time Turn-off switching losses	$V_{CC} = 200 \text{ V}$, $I_C = 1.5 \text{ A}$ $R_G = 22 \Omega$, $V_{clamp} = 400 \text{ V}$, $L = 1 \text{ mH}$, C-snubber = 2.7 nF, $T_C = 100^\circ\text{C}$ (see Figure 18)		19 3.5		ns μJ

1. Turn-off losses include also the tail of the collector current

Table 9. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_F	Forward on-voltage	$I_F = 1 \text{ A}$			1.3	V
		$I_F = 3 \text{ A}$		1.35		V
		$I_F = 3 \text{ A}, T_C = 125^\circ\text{C}$		1.15		V
t_{rr} Q_{rr} I_{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 3 \text{ A}, V_R = 40 \text{ V},$ $\text{di/dt} = 100 \text{ A}/\mu\text{s}$ (see Figure 19)		50		ns
				55		nC
				2.2		A
t_{rr} Q_{rr} I_{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 3 \text{ A}, V_R = 40 \text{ V},$ $T_C = 125^\circ\text{C}, \text{di/dt} = 100$ $\text{A}/\mu\text{s}$ (see Figure 19)		80		ns
				105		nC
				2.7		A

2.1 Electrical characteristics (curves)

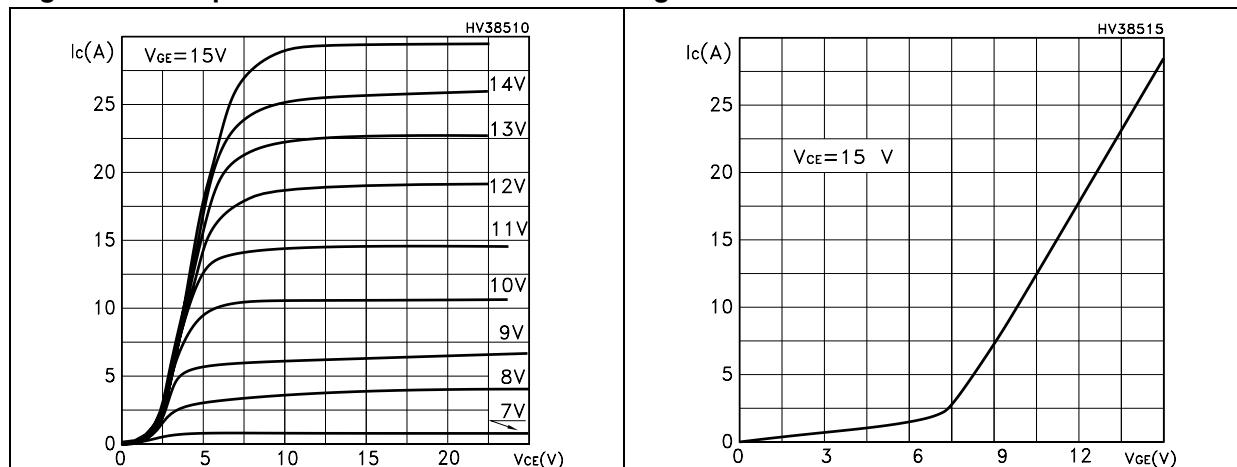
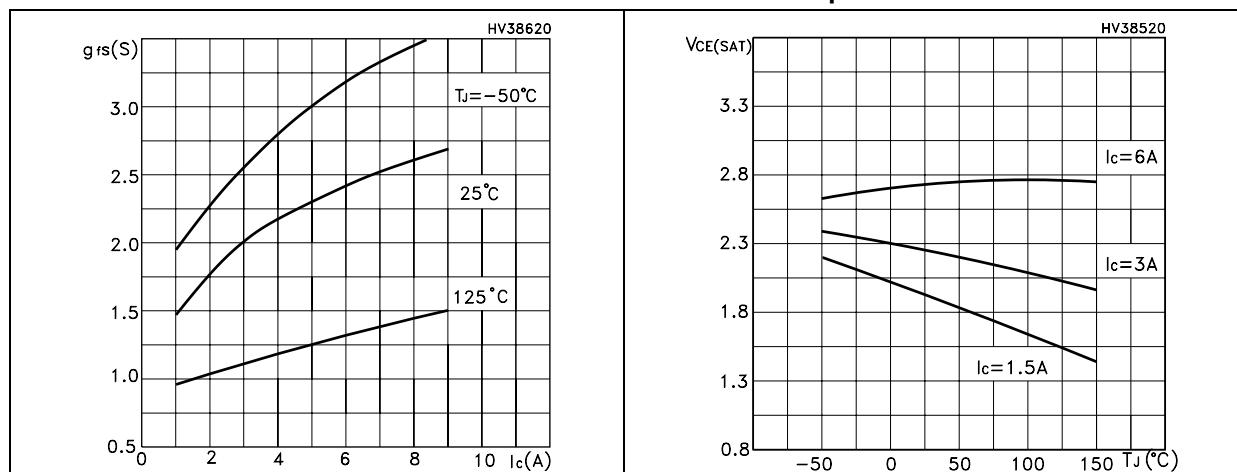
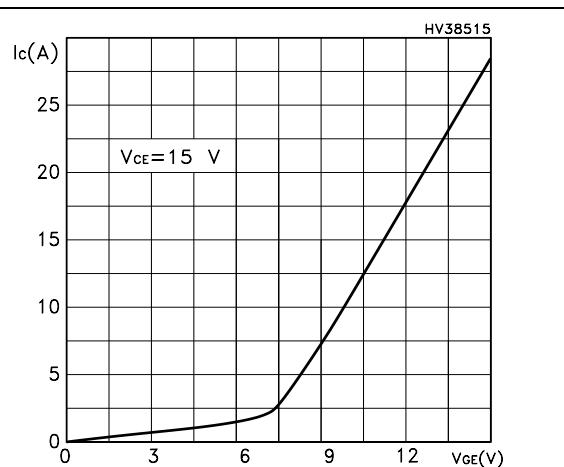
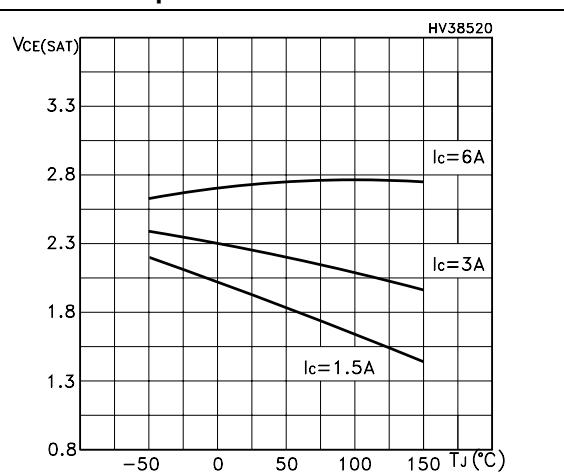
Figure 2. Output characteristics**Figure 4. Transconductance****Figure 3. Transfer characteristics****Figure 5. Collector-emitter on voltage vs. temperature**

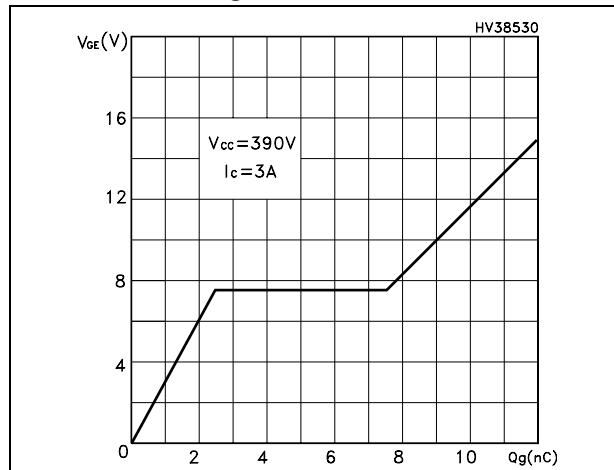
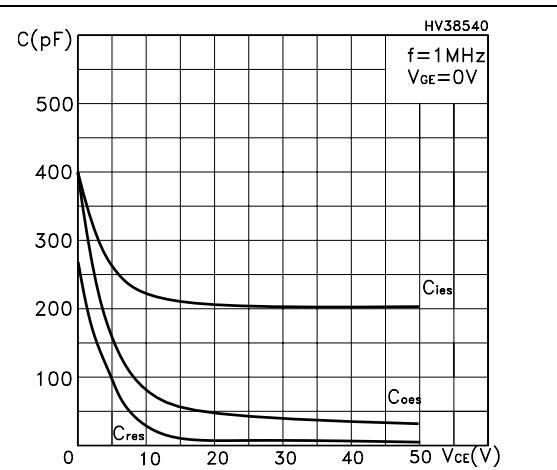
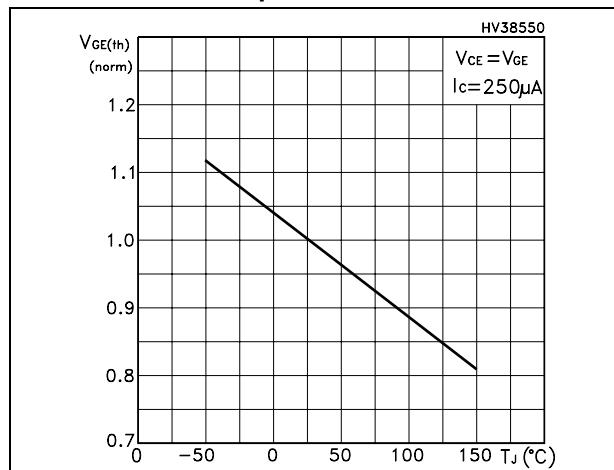
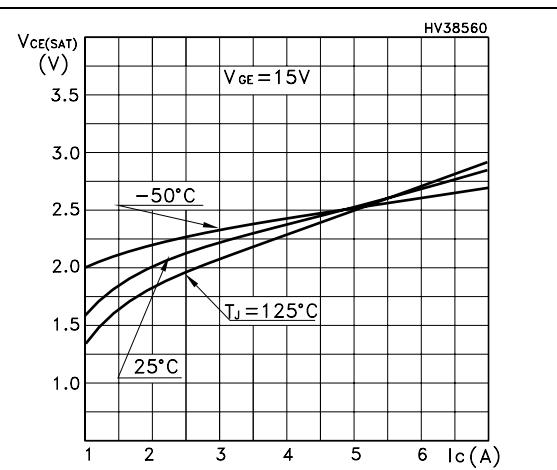
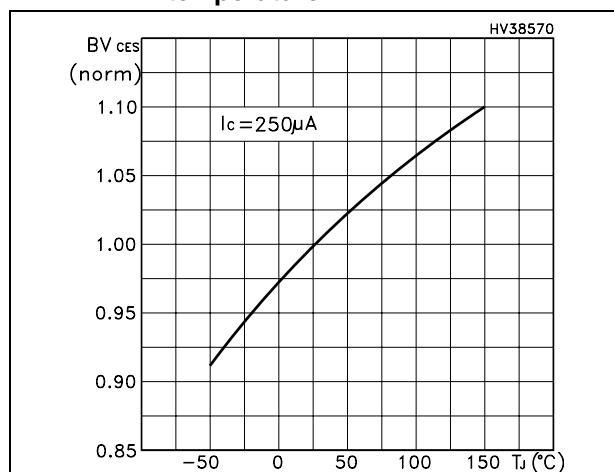
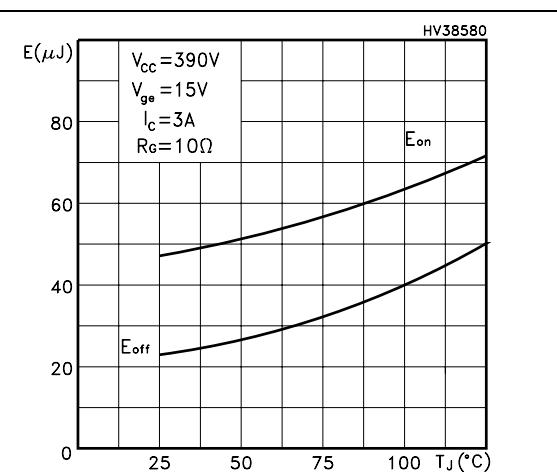
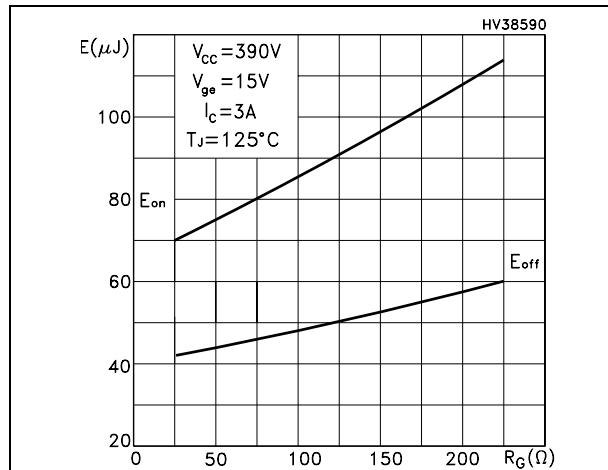
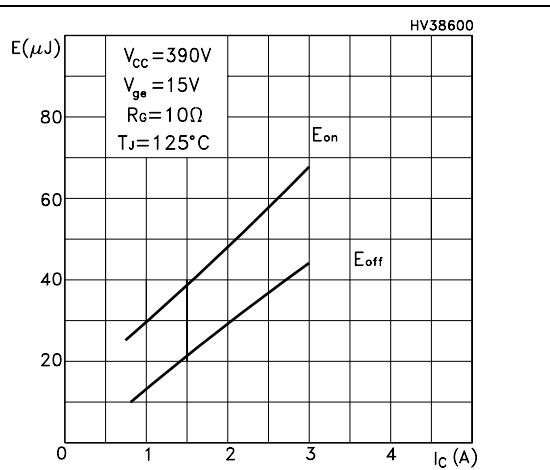
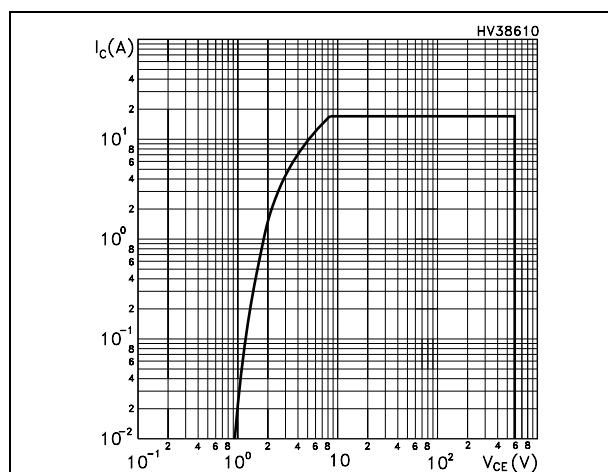
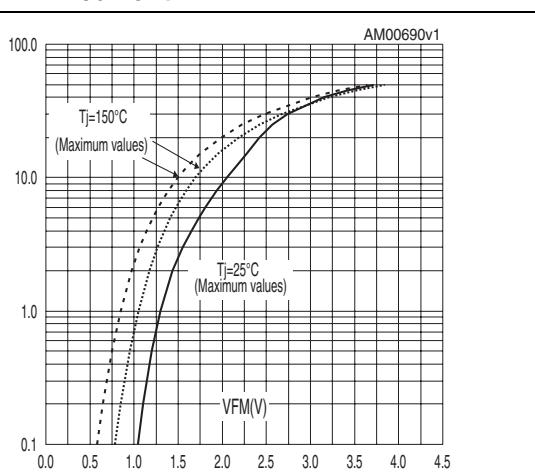
Figure 6. Gate charge vs. gate-source voltage**Figure 7. Capacitance variations****Figure 8. Normalized gate threshold voltage vs. temperature****Figure 9. Collector-emitter on voltage vs. collector current****Figure 10. Normalized breakdown voltage vs. temperature****Figure 11. Switching losses vs. temperature**

Figure 12. Switching losses vs. gate resistance**Figure 13. Switching losses vs. collector current****Figure 14. Turn-off SOA****Figure 15. Forward voltage drop vs. forward current**

3 Test circuit

Figure 16. Test circuit for inductive load switching

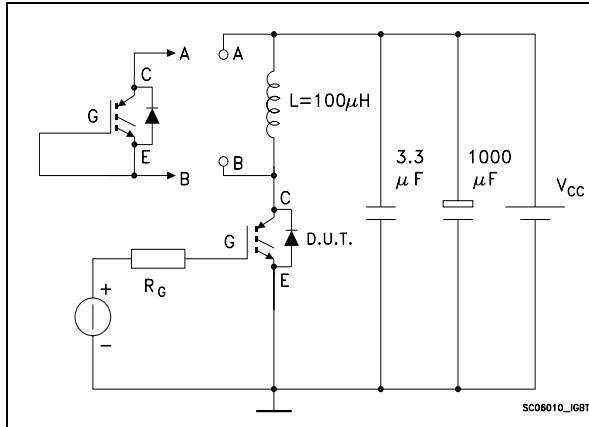


Figure 17. Gate charge test circuit

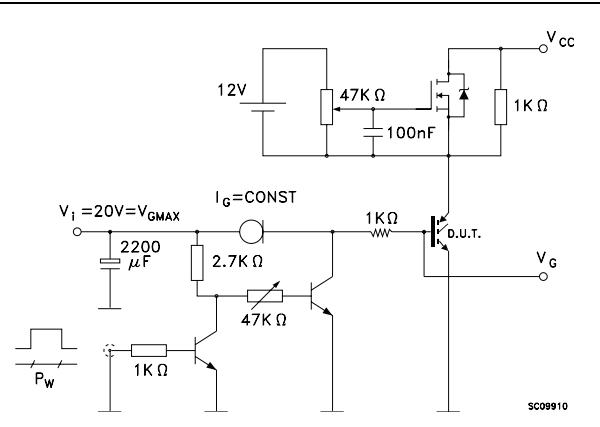


Figure 18. Switching waveform

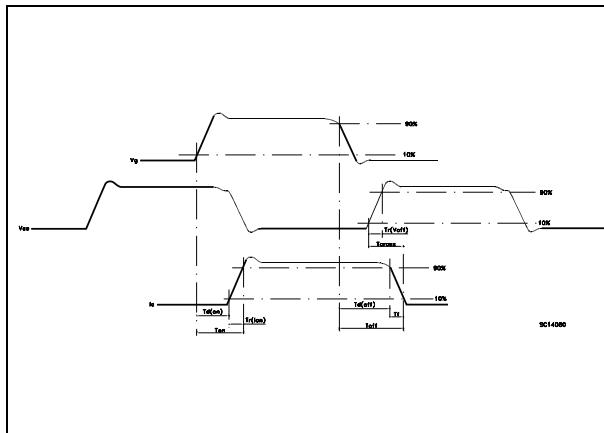
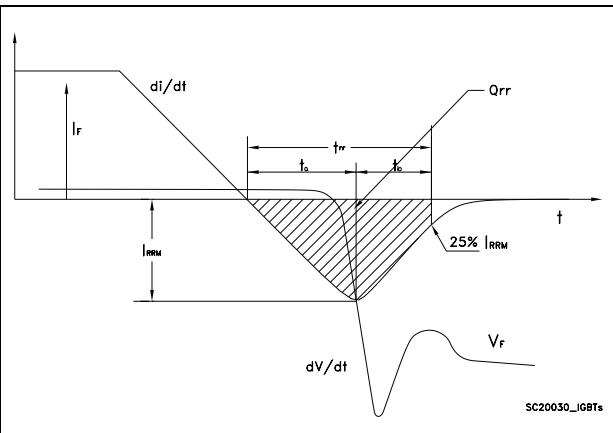


Figure 19. Diode recovery time waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
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Table 10. TO-220 type A mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
c	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
e	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

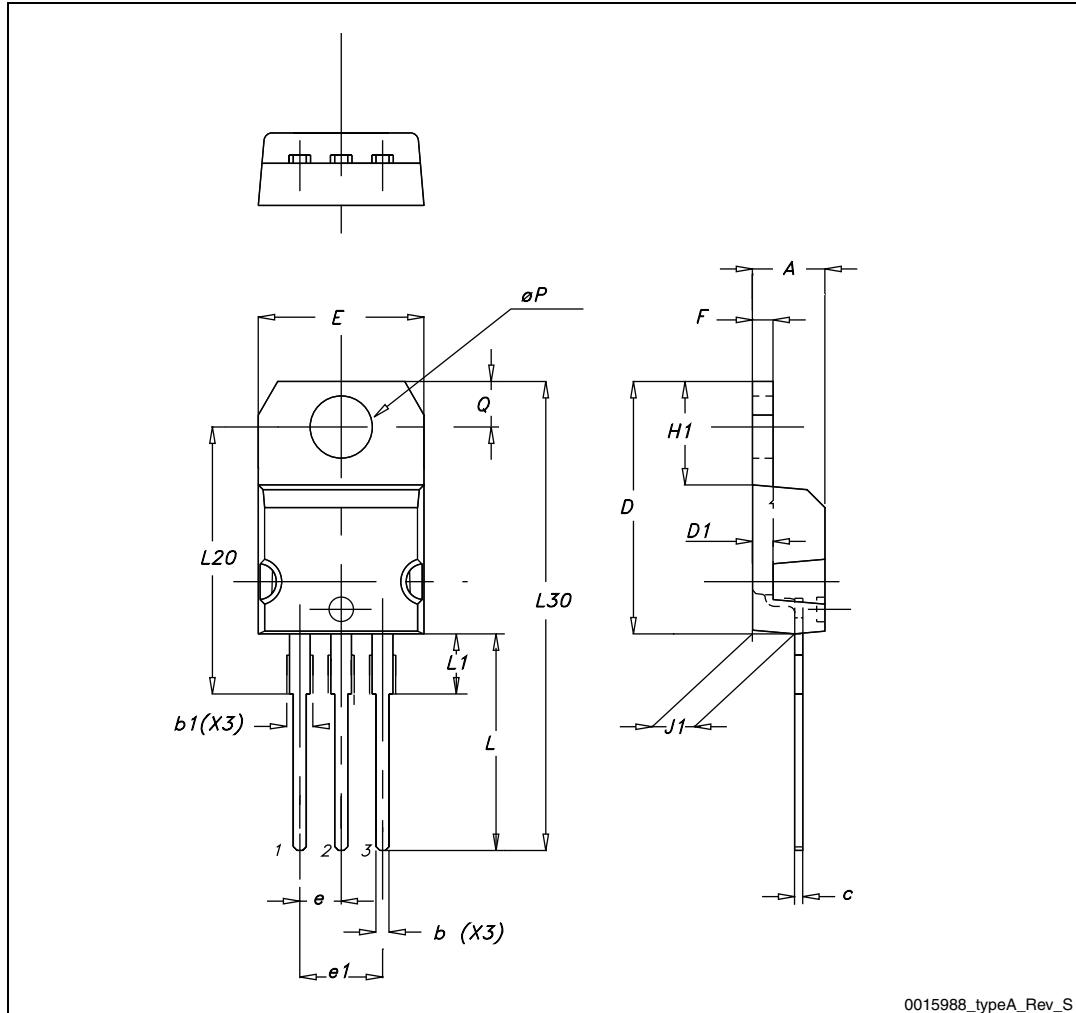
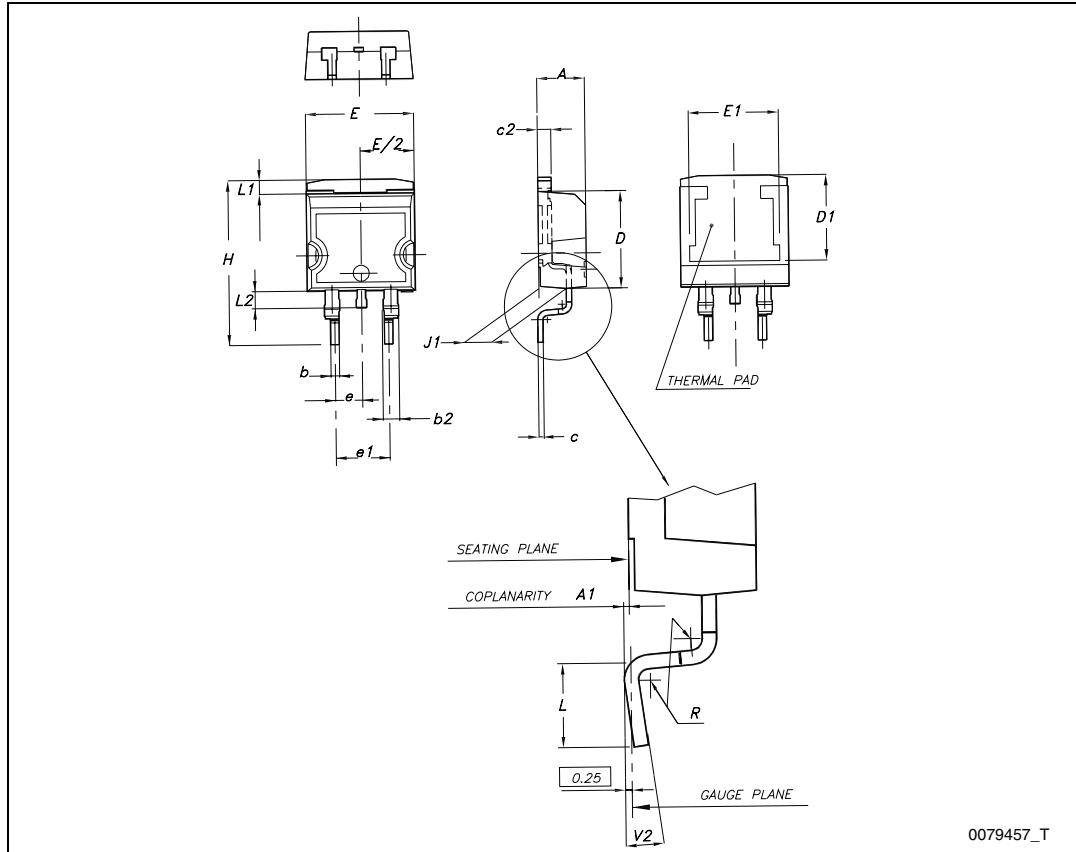
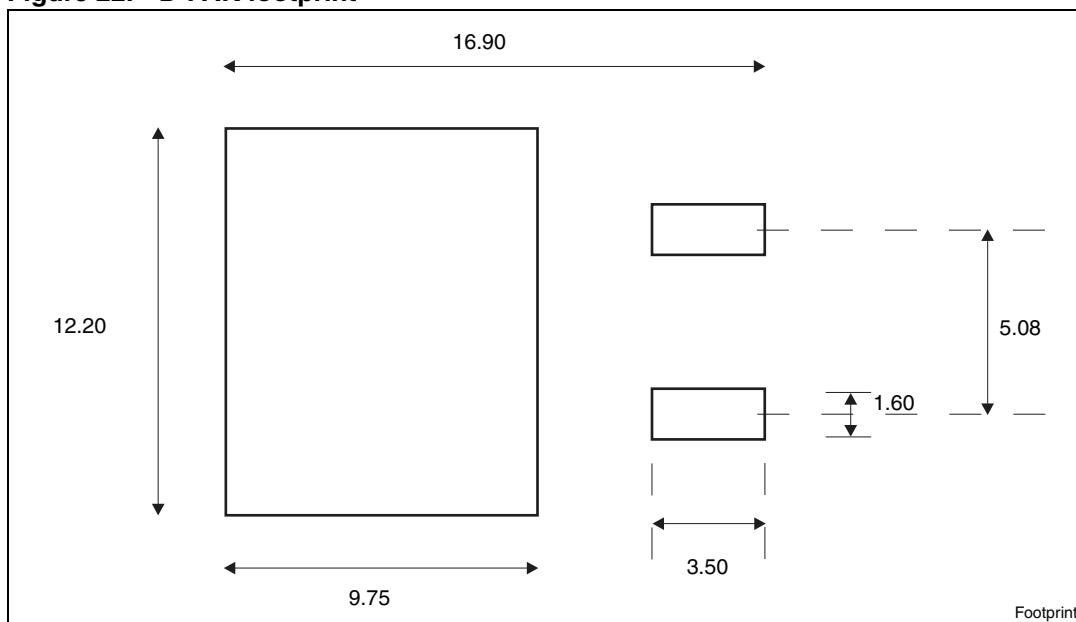
Figure 20. TO-220 type A drawing

Table 11. D²PAK (TO-263) mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.40		4.60
A1	0.03		0.23
b	0.70		0.93
b2	1.14		1.70
c	0.45		0.60
c2	1.23		1.36
D	8.95		9.35
D1	7.50		
E	10		10.40
E1	8.50		
e		2.54	
e1	4.88		5.28
H	15		15.85
J1	2.49		2.69
L	2.29		2.79
L1	1.27		1.40
L2	1.30		1.75
R		0.4	
V2	0°		8°

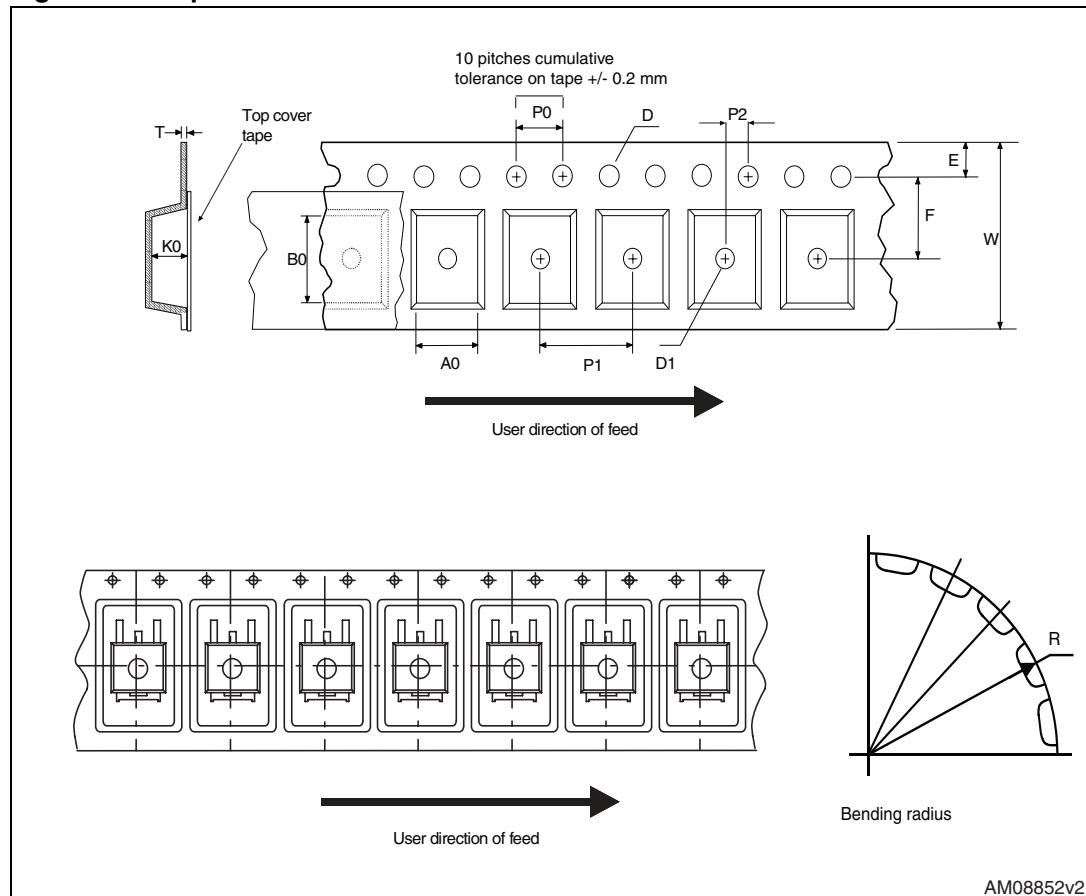
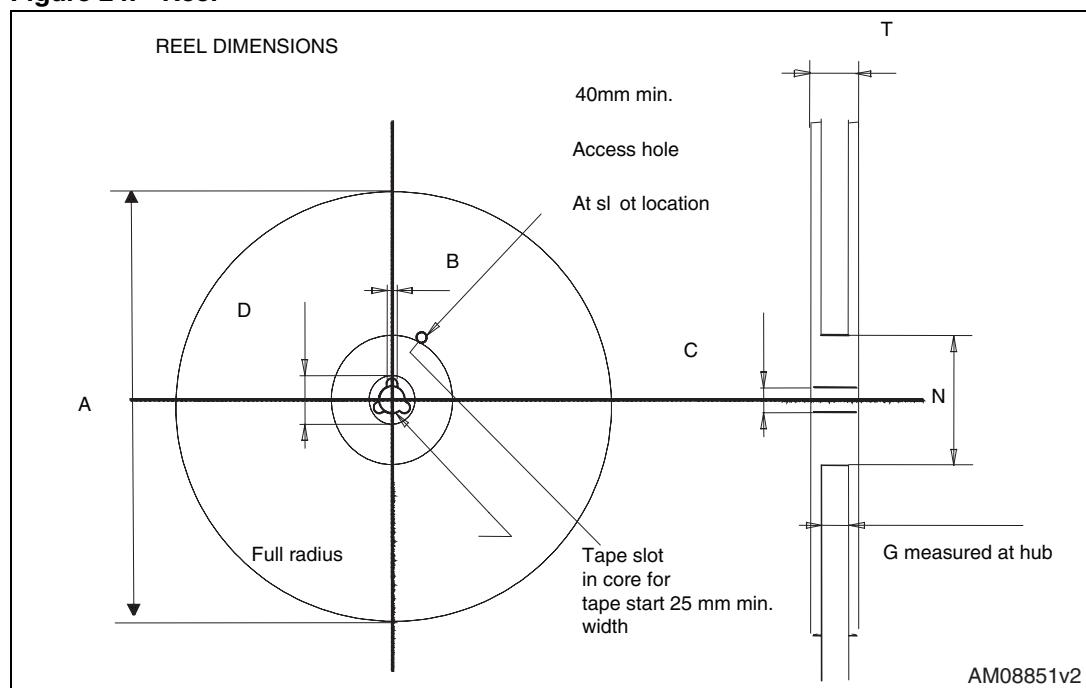
Figure 21. D²PAK (TO-263) drawing**Figure 22.** D²PAK footprint (a)

a. All dimension are in millimeters

5 Packaging mechanical data

Table 12. D²PAK (TO-263) tape and reel mechanical data

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.		Min.	Max.
A0	10.5	10.7	A		330
B0	15.7	15.9	B	1.5	
D	1.5	1.6	C	12.8	13.2
D1	1.59	1.61	D	20.2	
E	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	T		30.4
P0	3.9	4.1			
P1	11.9	12.1		Base qty	1000
P2	1.9	2.1		Bulk qty	1000
R	50				
T	0.25	0.35			
W	23.7	24.3			

Figure 23. Tape**Figure 24.** Reel

6 Revision history

Table 13. Document revision history

Date	Revision	Changes
27-Jul-2007	1	First release
09-Jul-2008	2	<i>4: Package mechanical data</i> has been updated.
21-Nov-2008	3	Updated <i>Table 9</i> and <i>Figure 15</i>
20-Sep-2012	4	Minor text changes in the Description. Updated: <i>Section 4: Package mechanical data on page 10</i> and <i>Section 5: Packaging mechanical data on page 14</i> .

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[IKZA40N65RH5XKSA1](#) [IKFW75N65ES5XKSA1](#) [IKFW50N65ES5XKSA1](#) [IKFW50N65EH5XKSA1](#) [IKFW40N65ES5XKSA1](#)
[IKFW60N65ES5XKSA1](#) [IMBG120R090M1HXTMA1](#) [IMBG120R220M1HXTMA1](#) [XD15H120CX1](#) [XD25H120CX0](#) [XP15PJS120CL1B1](#)
[IGW30N60H3FKSA1](#) [STGWA8M120DF3](#) [IGW08T120FKSA1](#) [IGW75N60H3FKSA1](#) [HGTG40N60B3](#) [FGH60N60SMD_F085](#)
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